

AMENDMENT TRANSMITTAL LETTER (Large Entity)Applicant(s): **S. SUNDAR KUMAR IYER ET AL.**

Docket No.

FIS920000372US1Application No.
09/878,556Filing Date
06/11/2001Examiner
J. CHENCustomer No.
29371Group Art Unit
2813Confirmation No.
3210Invention: **METHOD OF FORMING VARIABLE OXIDE THICKNESS ACROSS SEMICONDUCTOR CHIPS****COMMISSIONER FOR PATENTS:**

Transmitted herewith is an amendment in the above-identified application.
The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	20 -	23 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	6 -	6 =	0 x	\$88.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of _____
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- ☒ Any additional filing fees required under 37 C.F.R. 1.16.
- ☐ Any patent application processing fees under 37 CFR 1.17.
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Signature

Dated: **October 20, 2004**

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	S. SUNDAR KUMAR IYER, ET AL.)	
Serial No.:	09/878,556)	Group Art Unit: 2813
Filed:	June 11, 2001)	
For:	METHOD OF FORMING VARIABLE OXIDE THICKNESS ACROSS SEMICONDUCTOR CHIPS)	Examiner: Chen, J.
)	Confirmation No.: 3210

AMENDMENT AFTER FINAL REJECTION

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Final Office Action mailed September 7, 2004, please amend
the Application as follows: